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#### Understanding <u>Embedded - FPGAs (Field</u> <u>Programmable Gate Array)</u>

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

#### **Applications of Embedded - FPGAs**

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### Details

Product Status	Active
Number of LABs/CLBs	864
Number of Logic Elements/Cells	3888
Total RAM Bits	49152
Number of I/O	176
Number of Gates	150000
Voltage - Supply	2.375V ~ 2.625V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	256-BGA
Supplier Device Package	256-FBGA (17x17)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2s150-6fgg256c

Email: info@E-XFL.COM

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# Spartan-II FPGA Family: Introduction and Ordering Information

#### **Product Specification**

# Introduction

The Spartan<sup>®</sup>-II Field-Programmable Gate Array family gives users high performance, abundant logic resources, and a rich feature set, all at an exceptionally low price. The six-member family offers densities ranging from 15,000 to 200,000 system gates, as shown in Table 1. System performance is supported up to 200 MHz. Features include block RAM (to 56K bits), distributed RAM (to 75,264 bits), 16 selectable I/O standards, and four DLLs. Fast, predictable interconnect means that successive design iterations continue to meet timing requirements.

The Spartan-II family is a superior alternative to mask-programmed ASICs. The FPGA avoids the initial cost, lengthy development cycles, and inherent risk of conventional ASICs. Also, FPGA programmability permits design upgrades in the field with no hardware replacement necessary (impossible with ASICs).

# **Features**

- Second generation ASIC replacement technology
  - Densities as high as 5,292 logic cells with up to 200,000 system gates
  - Streamlined features based on Virtex<sup>®</sup> FPGA architecture
  - Unlimited reprogrammability
  - Very low cost
  - Cost-effective 0.18 micron process

- System level features
  - SelectRAM<sup>™</sup> hierarchical memory:
    - · 16 bits/LUT distributed RAM
    - Configurable 4K bit block RAM
    - Fast interfaces to external RAM
  - Fully PCI compliant
  - Low-power segmented routing architecture
  - Full readback ability for verification/observability
  - Dedicated carry logic for high-speed arithmetic
  - Efficient multiplier support
  - Cascade chain for wide-input functions
  - Abundant registers/latches with enable, set, reset
  - Four dedicated DLLs for advanced clock control
  - Four primary low-skew global clock distribution nets
  - IEEE 1149.1 compatible boundary scan logic
- Versatile I/O and packaging
  - Pb-free package options
  - Low-cost packages available in all densities
  - Family footprint compatibility in common packages
  - 16 high-performance interface standards
  - Hot swap Compact PCI friendly
  - Zero hold time simplifies system timing
- Core logic powered at 2.5V and I/Os powered at 1.5V, 2.5V, or 3.3V
- Fully supported by powerful Xilinx<sup>®</sup> ISE<sup>®</sup> development system
  - Fully automatic mapping, placement, and routing

Table 1: Spartan-II FPGA Family Members									
Device	Logic Cells	System Gates (Logic and RAM)	CLB Array (R x C)	Total CLBs	Maximum Available User I/O <sup>(1)</sup>	Total Distributed RAM Bits	Total Block RAM Bits		
XC2S15	432	15,000	8 x 12	96	86	6,144	16K		
XC2S30	972	30,000	12 x 18	216	92	13,824	24K		
XC2S50	1,728	50,000	16 x 24	384	176	24,576	32K		
XC2S100	2,700	100,000	20 x 30	600	176	38,400	40K		
XC2S150	3,888	150,000	24 x 36	864	260	55,296	48K		
XC2S200	5,292	200,000	28 x 42	1,176	284	75,264	56K		

#### Notes:

1. All user I/O counts do not include the four global clock/user input pins. See details in Table 2, page 4.

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# **General Overview**

The Spartan-II family of FPGAs have a regular, flexible, programmable architecture of Configurable Logic Blocks (CLBs), surrounded by a perimeter of programmable Input/Output Blocks (IOBs). There are four Delay-Locked Loops (DLLs), one at each corner of the die. Two columns of block RAM lie on opposite sides of the die, between the CLBs and the IOB columns. These functional elements are interconnected by a powerful hierarchy of versatile routing channels (see Figure 1).

Spartan-II FPGAs are customized by loading configuration data into internal static memory cells. Unlimited reprogramming cycles are possible with this approach. Stored values in these cells determine logic functions and interconnections implemented in the FPGA. Configuration data can be read from an external serial PROM (master serial mode), or written into the FPGA in slave serial, slave parallel, or Boundary Scan modes.

Spartan-II FPGAs are typically used in high-volume applications where the versatility of a fast programmable solution adds benefits. Spartan-II FPGAs are ideal for shortening product development cycles while offering a cost-effective solution for high volume production.

Spartan-II FPGAs achieve high-performance, low-cost operation through advanced architecture and semiconductor technology. Spartan-II devices provide system clock rates up to 200 MHz. In addition to the conventional benefits of high-volume programmable logic solutions, Spartan-II FPGAs also offer on-chip synchronous single-port and dual-port RAM (block and distributed form), DLL clock drivers, programmable set and reset on all flip-flops, fast carry logic, and many other features.







Figure 7: BUFT Connections to Dedicated Horizontal Bus Lines

# **Clock Distribution**

The Spartan-II family provides high-speed, low-skew clock distribution through the primary global routing resources described above. A typical clock distribution net is shown in Figure 8.

Four global buffers are provided, two at the top center of the device and two at the bottom center. These drive the four primary global nets that in turn drive any clock pin.

Four dedicated clock pads are provided, one adjacent to each of the global buffers. The input to the global buffer is selected either from these pads or from signals in the general purpose routing. Global clock pins do not have the option for internal, weak pull-up resistors.



Figure 8: Global Clock Distribution Network

# Delay-Locked Loop (DLL)

Associated with each global clock input buffer is a fully digital Delay-Locked Loop (DLL) that can eliminate skew between the clock input pad and internal clock-input pins throughout the device. Each DLL can drive two global clock networks. The DLL monitors the input clock and the distributed clock, and automatically adjusts a clock delay element. Additional delay is introduced such that clock edges reach internal flip-flops exactly one clock period after they arrive at the input. This closed-loop system effectively eliminates clock-distribution delay by ensuring that clock edges arrive at internal flip-flops in synchronism with clock edges arriving at the input.

In addition to eliminating clock-distribution delay, the DLL provides advanced control of multiple clock domains. The DLL provides four quadrature phases of the source clock, can double the clock, or divide the clock by 1.5, 2, 2.5, 3, 4, 5, 8, or 16. It has six outputs.

The DLL also operates as a clock mirror. By driving the output from a DLL off-chip and then back on again, the DLL can be used to deskew a board level clock among multiple Spartan-II devices.

In order to guarantee that the system clock is operating correctly prior to the FPGA starting up after configuration, the DLL can delay the completion of the configuration process until after it has achieved lock.

# **Boundary Scan**

Spartan-II devices support all the mandatory boundaryscan instructions specified in the IEEE standard 1149.1. A Test Access Port (TAP) and registers are provided that implement the EXTEST, SAMPLE/PRELOAD, and BYPASS instructions. The TAP also supports two USERCODE instructions and internal scan chains.

The TAP uses dedicated package pins that always operate using LVTTL. For TDO to operate using LVTTL, the V<sub>CCO</sub> for Bank 2 must be 3.3V. Otherwise, TDO switches rail-to-rail between ground and V<sub>CCO</sub>. TDI, TMS, and TCK have a default internal weak pull-up resistor, and TDO has no default resistor. Bitstream options allow setting any of the four TAP pins to have an internal pull-up, pull-down, or neither.

# Configuration

Configuration is the process by which the bitstream of a design, as generated by the Xilinx software, is loaded into the internal configuration memory of the FPGA. Spartan-II devices support both serial configuration, using the master/slave serial and JTAG modes, as well as byte-wide configuration employing the Slave Parallel mode.

# **Configuration File**

Spartan-II devices are configured by sequentially loading frames of data that have been concatenated into a configuration file. Table 8 shows how much nonvolatile storage space is needed for Spartan-II devices.

It is important to note that, while a PROM is commonly used to store configuration data before loading them into the FPGA, it is by no means required. Any of a number of different kinds of under populated nonvolatile storage already available either on or off the board (i.e., hard drives, FLASH cards, etc.) can be used. For more information on configuration without a PROM, refer to <u>XAPP098</u>, *The Low-Cost, Efficient Serial Configuration of Spartan FPGAs*.

Device	Configuration File Size (Bits)
XC2S15	197,696
XC2S30	336,768
XC2S50	559,200
XC2S100	781,216
XC2S150	1,040,096
XC2S200	1,335,840

#### Table 8: Spartan-II Configuration File Size

## Modes

Spartan-II devices support the following four configuration modes:

- Slave Serial mode
- Master Serial mode
- Slave Parallel mode
- Boundary-scan mode

The Configuration mode pins (M2, M1, M0) select among these configuration modes with the option in each case of having the IOB pins either pulled up or left floating prior to the end of configuration. The selection codes are listed in Table 9.

Configuration through the boundary-scan port is always available, independent of the mode selection. Selecting the boundary-scan mode simply turns off the other modes. The three mode pins have internal pull-up resistors, and default to a logic High if left unconnected.

Configuration Mode	Preconfiguration Pull-ups	МО	M1	M2	CCLK Direction	Data Width	Serial D <sub>OUT</sub>
Master Serial mode	No	0	0	0	Out	1	Yes
	Yes	0	0	1			
Slave Parallel mode	Yes	0	1	0	In	8	No
	No	0	1	1			
Boundary-Scan mode	Yes	1	0	0	N/A	1	No
	No	1	0	1			
Slave Serial mode	Yes	1	1	0	In	1	Yes
	No	1	1	1			

## Table 9: Configuration Modes

#### Notes:

 During power-on and throughout configuration, the I/O drivers will be in a high-impedance state. After configuration, all unused I/Os (those not assigned signals) will remain in a high-impedance state. Pins used as outputs may pulse High at the end of configuration (see <u>Answer 10504</u>).

2. If the Mode pins are set for preconfiguration pull-ups, those resistors go into effect once the rising edge of INIT samples the Mode pins. They will stay in effect until GTS is released during startup, after which the UnusedPin bitstream generator option will determine whether the unused I/Os have a pull-up, pull-down, or no resistor.

By default, these operations are synchronized to CCLK. The entire start-up sequence lasts eight cycles, called C0-C7, after which the loaded design is fully functional. The default timing for start-up is shown in the top half of Figure 13. The four operations can be selected to switch on any CCLK cycle C1-C6 through settings in the Xilinx software. Heavy lines show default settings.



Figure 13: Start-Up Waveforms

The bottom half of Figure 13 shows another commonly used version of the start-up timing known as Sync-to-DONE. This version makes the GTS, GSR, and GWE events conditional upon the DONE pin going High. This timing is important for a daisy chain of multiple FPGAs in serial mode, since it ensures that all FPGAs go through start-up together, after all their DONE pins have gone High.

Sync-to-DONE timing is selected by setting the GTS, GSR, and GWE cycles to a value of DONE in the configuration options. This causes these signals to transition one clock cycle after DONE externally transitions High.

## **Serial Modes**

There are two serial configuration modes: In Master Serial mode, the FPGA controls the configuration process by driving CCLK as an output. In Slave Serial mode, the FPGA passively receives CCLK as an input from an external agent (e.g., a microprocessor, CPLD, or second FPGA in master mode) that is controlling the configuration process. In both modes, the FPGA is configured by loading one bit per CCLK cycle. The MSB of each configuration data byte is always written to the DIN pin first.

See Figure 14 for the sequence for loading data into the Spartan-II FPGA serially. This is an expansion of the "Load Configuration Data Frames" block in Figure 11. Note that CS and WRITE normally are not used during serial configuration. To ensure successful loading of the FPGA, do not toggle WRITE with CS Low during serial configuration.





If CCLK is slower than  $\rm F_{CCNH},$  the FPGA will never assert BUSY. In this case, the above handshake is unnecessary, and data can simply be entered into the FPGA every CCLK cycle.



## Figure 19: Loading Configuration Data for the Slave Parallel Mode

A configuration packet does not have to be written in one continuous stretch, rather it can be split into many write sequences. Each sequence would involve assertion of  $\overline{CS}$ .

In applications where multiple clock cycles may be required to access the configuration data before each byte can be loaded into the Slave Parallel interface, a new byte of data may not be ready for each consecutive CCLK edge. In such a case the  $\overline{CS}$  signal may be de-asserted until the next byte is valid on D0-D7. While  $\overline{CS}$  is High, the Slave Parallel interface does not expect any data and ignores all CCLK transitions. However, to avoid aborting configuration, WRITE must continue to be asserted while CS is asserted.

#### Abort

To abort configuration during a write sequence, de-assert  $\overline{\text{WRITE}}$  while holding  $\overline{\text{CS}}$  Low. The abort operation is initiated at the rising edge of CCLK, as shown in Figure 21, page 26. The device will remain BUSY until the aborted operation is complete. After aborting configuration, data is assumed to be unaligned to word boundaries and the FPGA requires a new synchronization word prior to accepting any new packets.

## **Boundary-Scan Mode**

In the boundary-scan mode, no nondedicated pins are required, configuration being done entirely through the IEEE 1149.1 Test Access Port.

Configuration through the TAP uses the special CFG\_IN instruction. This instruction allows data input on TDI to be converted into data packets for the internal configuration bus.

The following steps are required to configure the FPGA through the boundary-scan port.

- 1. Load the CFG\_IN instruction into the boundary-scan instruction register (IR)
- 2. Enter the Shift-DR (SDR) state
- 3. Shift a standard configuration bitstream into TDI
- 4. Return to Run-Test-Idle (RTI)
- 5. Load the JSTART instruction into IR
- 6. Enter the SDR state
- 7. Clock TCK through the sequence (the length is programmable)
- 8. Return to RTI

Configuration and readback via the TAP is always available. The boundary-scan mode simply locks out the other modes. The boundary-scan mode is selected by a <10x> on the mode pins (M0, M1, M2).

# Readback

The configuration data stored in the Spartan-II FPGA configuration memory can be readback for verification. Along with the configuration data it is possible to readback the contents of all flip-flops/latches, LUT RAMs, and block RAMs. This capability is used for real-time debugging.

For more detailed information see <u>XAPP176</u>, Spartan-II FPGA Family Configuration and Readback.



Figure 20: Slave Parallel Write Timing



Figure 21: Slave Parallel Write Abort Waveforms

# **Design Considerations**

This section contains more detailed design information on the following features:

- Delay-Locked Loop . . . see page 27
- Block RAM . . . see page 32
- Versatile I/O . . . see page 36

# Using Delay-Locked Loops

The Spartan-II FPGA family provides up to four fully digital dedicated on-chip Delay-Locked Loop (DLL) circuits which provide zero propagation delay, low clock skew between output clock signals distributed throughout the device, and advanced clock domain control. These dedicated DLLs can be used to implement several circuits that improve and simplify system level design.

## Introduction

Quality on-chip clock distribution is important. Clock skew and clock delay impact device performance and the task of managing clock skew and clock delay with conventional clock trees becomes more difficult in large devices. The Spartan-II family of devices resolve this potential problem by providing up to four fully digital dedicated on-chip Delay-Locked Loop (DLL) circuits which provide zero propagation delay and low clock skew between output clock signals distributed throughout the device.

Each DLL can drive up to two global clock routing networks within the device. The global clock distribution network minimizes clock skews due to loading differences. By monitoring a sample of the DLL output clock, the DLL can compensate for the delay on the routing network, effectively eliminating the delay from the external input port to the individual clock loads within the device.

In addition to providing zero delay with respect to a user source clock, the DLL can provide multiple phases of the source clock. The DLL can also act as a clock doubler or it can divide the user source clock by up to 16.

Clock multiplication gives the designer a number of design alternatives. For instance, a 50 MHz source clock doubled by the DLL can drive an FPGA design operating at 100 MHz. This technique can simplify board design because the clock path on the board no longer distributes such a high-speed signal. A multiplied clock also provides designers the option of time-domain-multiplexing, using one circuit twice per clock cycle, consuming less area than two copies of the same circuit.

The DLL can also act as a clock mirror. By driving the DLL output off-chip and then back in again, the DLL can be used to de-skew a board level clock between multiple devices.

In order to guarantee the system clock establishes prior to the device "waking up," the DLL can delay the completion of the device configuration process until after the DLL achieves lock.

By taking advantage of the DLL to remove on-chip clock delay, the designer can greatly simplify and improve system level design involving high-fanout, high-performance clocks.

## **Library DLL Primitives**

Figure 22 shows the simplified Xilinx library DLL macro, BUFGDLL. This macro delivers a quick and efficient way to provide a system clock with zero propagation delay throughout the device. Figure 23 and Figure 24 show the two library DLL primitives. These primitives provide access to the complete set of DLL features when implementing more complex applications.



Figure 22: Simplified DLL Macro BUFGDLL



DS001\_23\_032300





DS001\_24\_032300



## HSTL Class III

A sample circuit illustrating a valid termination technique for HSTL\_III appears in Figure 45. DC voltage specifications appear in Table 23 for the HSTL\_III standard. See "DC Specifications" in Module 3 for the actual FPGA characteristics.

#### HSTL Class III



Figure 45: Terminated HSTL Class III

Table	23:	HSTL	Class	III	Voltage	Specification	n
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Parameter	Min	Тур	Мах
V <sub>CCO</sub>	1.40	1.50	1.60
V <sub>REF</sub> <sup>(1)</sup>	-	0.90	-
V <sub>TT</sub>	-	V <sub>CCO</sub>	-
V <sub>IH</sub>	V <sub>REF</sub> + 0.1	-	-
V <sub>IL</sub>	-	-	$V_{REF} - 0.1$
V <sub>OH</sub>	$V_{CCO} - 0.4$	-	-
V <sub>OL</sub>	-	-	0.4
I <sub>OH</sub> at V <sub>OH</sub> (mA)	-8	-	-
I <sub>OL</sub> at V <sub>OL</sub> (mA)	24	-	-

#### Notes:

1. Per EIA/JESD8-6, "The value of V<sub>REF</sub> is to be selected by the user to provide optimum noise margin in the use conditions specified by the user."

#### **HSTL Class IV**

A sample circuit illustrating a valid termination technique for HSTL\_IV appears in Figure 46.DC voltage specifications appear in Table 23 for the HSTL\_IV standard. See "DC Specifications" in Module 3 for the actual FPGA characteristics



Figure 46: Terminated HSTL Class IV

#### Table 24: HSTL Class IV Voltage Specification

Parameter	Min	Тур	Max
V <sub>CCO</sub>	1.40	1.50	1.60
V <sub>REF</sub>	-	0.90	-
V <sub>TT</sub>	-	V <sub>CCO</sub>	-
V <sub>IH</sub>	V <sub>REF</sub> + 0.1	-	-
V <sub>IL</sub>	-	-	V <sub>REF</sub> – 0.1
V <sub>OH</sub>	$V_{CCO} - 0.4$	-	-
V <sub>OL</sub>	-	-	0.4
I <sub>OH</sub> at V <sub>OH</sub> (mA)	-8	-	-
I <sub>OL</sub> at V <sub>OL</sub> (mA)	48	-	-

Notes:

 Per EIA/JESD8-6, "The value of V<sub>REF</sub> is to be selected by the user to provide optimum noise margin in the use conditions specified by the user."

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## СТТ

A sample circuit illustrating a valid termination technique for CTT appear in Figure 51. DC voltage specifications appear in Table 29 for the CTT standard. See "DC Specifications" in Module 3 for the actual FPGA characteristics .



Figure 51: Terminated CTT

#### Table 29: CTT Voltage Specifications

Parameter	Min	Тур	Max
V <sub>CCO</sub>	2.05 <sup>(1)</sup>	3.3	3.6
V <sub>REF</sub>	1.35	1.5	1.65
V <sub>TT</sub>	1.35	1.5	1.65
$V_{IH} \ge V_{REF} + 0.2$	1.55	1.7	-
$V_{IL} \leq V_{REF} - 0.2$	-	1.3	1.45
$V_{OH} \ge V_{REF} + 0.4$	1.75	1.9	-
$V_{OL} \leq V_{REF} - 0.4$	-	1.1	1.25
I <sub>OH</sub> at V <sub>OH</sub> (mA)	-8	-	-
I <sub>OL</sub> at V <sub>OL</sub> (mA)	8	-	-

#### Notes:

1. Timing delays are calculated based on  $V_{CCO}$  min of 3.0V.

## PCI33\_3 and PCI66\_3

PCI33\_3 or PCI66\_3 require no termination. DC voltage specifications appear in Table 30 for the PCI33\_3 and PCI66\_3 standards. See "DC Specifications" in Module 3 for the actual FPGA characteristics.

#### Table 30: PCI33\_3 and PCI66\_3 Voltage Specifications

Parameter	Min	Тур	Max
V <sub>CCO</sub>	3.0	3.3	3.6
V <sub>REF</sub>	-	-	-
V <sub>TT</sub>	-	-	-
$V_{IH} = 0.5 \times V_{CCO}$	1.5	1.65	V <sub>CCO</sub> + 0.5
$V_{IL} = 0.3 \times V_{CCO}$	-0.5	0.99	1.08
$V_{OH} = 0.9 \times V_{CCO}$	2.7	-	-
$V_{OL} = 0.1 \times V_{CCO}$	-	-	0.36
I <sub>OH</sub> at V <sub>OH</sub> (mA)	Note 1	-	-
I <sub>OL</sub> at V <sub>OL</sub> (mA)	Note 1	-	-

#### Notes:

1. Tested according to the relevant specification.

## PCI33\_5

PCI33\_5 requires no termination. DC voltage specifications appear in Table 31 for the PCI33\_5 standard. See "DC Specifications" in Module 3 for the actual FPGA characteristics.

#### Table 31: PCI33\_5 Voltage Specifications

Parameter	Min	Тур	Max
V <sub>CCO</sub>	3.0	3.3	3.6
V <sub>REF</sub>	-	-	-
V <sub>TT</sub>	-	-	-
V <sub>IH</sub>	1.425	1.5	5.5
V <sub>IL</sub>	-0.5	1.0	1.05
V <sub>OH</sub>	2.4	-	-
V <sub>OL</sub>	-	-	0.55
I <sub>OH</sub> at V <sub>OH</sub> (mA)	Note 1	-	-
I <sub>OL</sub> at V <sub>OL</sub> (mA)	Note 1	-	-

#### Notes:

1. Tested according to the relevant specification.

# **Power-On Requirements**

Spartan-II FPGAs require that a minimum supply current  $I_{CCPO}$  be provided to the  $V_{CCINT}$  lines for a successful power-on. If more current is available, the FPGA can consume more than  $I_{CCPO}$  minimum, though this cannot adversely affect reliability.

A maximum limit for  $I_{CCPO}$  is not specified. Therefore the use of foldback/crowbar supplies and fuses deserves special attention. In these cases, limit the  $I_{CCPO}$  current to a level below the trip point for over-current protection in order to avoid inadvertently shutting down the supply.

		Conditions		New Requirements <sup>(1)</sup> For Devices with Date Code 0321 or Later		Old Requirements <sup>(1)</sup> For Devices with Date Code before 0321		
Symbol	Description	Junction Temperature <sup>(2)</sup>	Device Temperature Grade	Min	Max	Min	Мах	Units
I <sub>CCPO</sub> <sup>(3)</sup>	Total V <sub>CCINT</sub> supply	$-40^{\circ}C \le T_{J} < -20^{\circ}C$	Industrial	1.50	-	2.00	-	A
	current required	$-20^{\circ}C \le T_{J} < 0^{\circ}C$	Industrial	1.00	-	2.00	-	A
	auring power-on	$0^{\circ}C \leq T_{J} \leq 85^{\circ}C$	Commercial	0.25	-	0.50	-	Α
		$85^{\circ}C < T_{J} \leq 100^{\circ}C$	Industrial	0.50	-	0.50	-	Α
T <sub>CCPO</sub> <sup>(4,5)</sup>	V <sub>CCINT</sub> ramp time	–40°C≤ T <sub>J</sub> ≤ 100°C	All	-	50	-	50	ms

#### Notes:

1. The date code is printed on the top of the device's package. See the "Device Part Marking" section in Module 1.

2. The expected T<sub>J</sub> range for the design determines the I<sub>CCPO</sub> minimum requirement. Use the applicable ranges in the junction temperature column to find the associated current values in the appropriate new or old requirements column according to the date code. Then choose the highest of these current values to serve as the minimum I<sub>CCPO</sub> requirement that must be met. For example, if the junction temperature for a given design is -25°C ≤ T<sub>J</sub> ≤ 75°C, then the new minimum I<sub>CCPO</sub> requirement is 1.5A. If 5°C ≤ T<sub>J</sub> ≤ 90°C, then the new minimum I<sub>CCPO</sub> requirement is 0.5A.

3. The I<sub>CCPO</sub> requirement applies for a brief time (commonly only a few milliseconds) when V<sub>CCINT</sub> ramps from 0 to 2.5V.

4. The ramp time is measured from GND to V<sub>CCINT</sub> max on a fully loaded board.

5. During power-on, the V<sub>CCINT</sub> ramp must increase steadily in voltage with no dips.

6. For more information on designing to meet the power-on specifications, refer to the application note <u>XAPP450 "Power-On Current</u> <u>Requirements for the Spartan-II and Spartan-IIE Families"</u>

# **DC Input and Output Levels**

Values for  $V_{IL}$  and  $V_{IH}$  are recommended input voltages. Values for  $V_{OL}$  and  $V_{OH}$  are guaranteed output voltages over the recommended operating conditions. Only selected standards are tested. These are chosen to ensure that all standards meet their specifications. The selected standards are tested at minimum V<sub>CCO</sub> with the respective I<sub>OL</sub> and I<sub>OH</sub> currents shown. Other standards are sample tested.

Input/Output		V <sub>IL</sub>	V	ін	V <sub>OL</sub>	V <sub>OH</sub>	I <sub>OL</sub>	I <sub>ОН</sub>
Standard	V, Min	V, Max	V, Min	V, Max	V, Max	V, Min	mA	mA
LVTTL <sup>(1)</sup>	-0.5	0.8	2.0	5.5	0.4	2.4	24	-24
LVCMOS2	-0.5	0.7	1.7	5.5	0.4	1.9	12	-12
PCI, 3.3V	-0.5	44% V <sub>CCINT</sub>	60% V <sub>CCINT</sub>	V <sub>CCO</sub> + 0.5	10% V <sub>CCO</sub>	90% V <sub>CCO</sub>	Note (2)	Note (2)
PCI, 5.0V	-0.5	0.8	2.0	5.5	0.55	2.4	Note (2)	Note (2)
GTL	-0.5	V <sub>REF</sub> – 0.05	V <sub>REF</sub> + 0.05	3.6	0.4	N/A	40	N/A
GTL+	-0.5	V <sub>REF</sub> – 0.1	V <sub>REF</sub> + 0.1	3.6	0.6	N/A	36	N/A
HSTL I	-0.5	V <sub>REF</sub> – 0.1	V <sub>REF</sub> + 0.1	3.6	0.4	V <sub>CCO</sub> – 0.4	8	-8
HSTL III	-0.5	V <sub>REF</sub> – 0.1	V <sub>REF</sub> + 0.1	3.6	0.4	V <sub>CCO</sub> – 0.4	24	-8
HSTL IV	-0.5	V <sub>REF</sub> – 0.1	V <sub>REF</sub> + 0.1	3.6	0.4	V <sub>CCO</sub> – 0.4	48	-8
SSTL3 I	-0.5	V <sub>REF</sub> – 0.2	V <sub>REF</sub> + 0.2	3.6	V <sub>REF</sub> – 0.6	V <sub>REF</sub> + 0.6	8	-8
SSTL3 II	-0.5	V <sub>REF</sub> – 0.2	V <sub>REF</sub> + 0.2	3.6	V <sub>REF</sub> – 0.8	V <sub>REF</sub> + 0.8	16	-16
SSTL2 I	-0.5	V <sub>REF</sub> – 0.2	V <sub>REF</sub> + 0.2	3.6	V <sub>REF</sub> – 0.6	V <sub>REF</sub> + 0.6	7.6	-7.6
SSTL2 II	-0.5	V <sub>REF</sub> – 0.2	V <sub>REF</sub> + 0.2	3.6	V <sub>REF</sub> – 0.8	V <sub>REF</sub> + 0.8	15.2	-15.2

# IOB Input Delay Adjustments for Different Standards<sup>(1)</sup>

Input delays associated with the pad are specified for LVTTL. For other standards, adjust the delays by the values shown. A delay adjusted in this way constitutes a worst-case limit.

			Speed	Speed Grade					
Symbol	Description	Standard	-6	-5	Units				
Data Input Delay Adjustments									
T <sub>ILVTTL</sub>	Standard-specific data input delay	LVTTL	0	0	ns				
T <sub>ILVCMOS2</sub>	adjustments	LVCMOS2	-0.04	-0.05	ns				
T <sub>IPCI33_3</sub>		PCI, 33 MHz, 3.3V	-0.11	-0.13	ns				
T <sub>IPCI33_5</sub>		PCI, 33 MHz, 5.0V	0.26	0.30	ns				
T <sub>IPCI66_3</sub>		PCI, 66 MHz, 3.3V	-0.11	-0.13	ns				
T <sub>IGTL</sub>		GTL	0.20	0.24	ns				
T <sub>IGTLP</sub>		GTL+	0.11	0.13	ns				
T <sub>IHSTL</sub>		HSTL	0.03	0.04	ns				
T <sub>ISSTL2</sub>		SSTL2	-0.08	-0.09	ns				
T <sub>ISSTL3</sub>		SSTL3	-0.04	-0.05	ns				
T <sub>ICTT</sub>		СТТ	0.02	0.02	ns				
T <sub>IAGP</sub>		AGP	-0.06	-0.07	ns				

Notes:

1. Input timing for LVTTL is measured at 1.4V. For other I/O standards, see the table "Delay Measurement Methodology," page 60.

## **IOB Output Switching Characteristics**

Output delays terminating at a pad are specified for LVTTL with 12 mA drive and fast slew rate. For other standards, adjust the delays with the values shown in "IOB Output Delay Adjustments for Different Standards," page 59.

		Speed Grade				
	-6			-5		
Symbol	Description	Min	Max	Min	Max	Units
Propagation Delays	5					
T <sub>IOOP</sub>	O input to pad	-	2.9	-	3.4	ns
T <sub>IOOLP</sub>	O input to pad via transparent latch	-	3.4	-	4.0	ns
3-state Delays		1				
T <sub>IOTHZ</sub>	T input to pad high-impedance <sup>(1)</sup>	-	2.0	-	2.3	ns
T <sub>IOTON</sub>	T input to valid data on pad	-	3.0	-	3.6	ns
T <sub>IOTLPHZ</sub>	T input to pad high impedance via transparent latch <sup>(1)</sup>	-	2.5	-	2.9	ns
T <sub>IOTLPON</sub>	T input to valid data on pad via transparent latch	-	3.5	-	4.2	ns
T <sub>GTS</sub>	GTS to pad high impedance <sup>(1)</sup>	-	5.0	-	5.9	ns
Sequential Delays		1	L	1		
T <sub>IOCKP</sub>	Clock CLK to pad	-	2.9	-	3.4	ns
Т <sub>ЮСКНZ</sub>	Clock CLK to pad high impedance (synchronous) <sup>(1)</sup>	-	2.3	-	2.7	ns
T <sub>IOCKON</sub>	Clock CLK to valid data on pad (synchronous)	-	3.3	-	4.0	ns
Setup/Hold Times	with Respect to Clock CLK <sup>(2)</sup>	1	l.			
TIOOCK / TIOCKO	O input	1.1/0	-	1.3/0	-	ns
T <sub>IOOCECK</sub> /	OCE input	0.9 / 0.01	-	0.9/0.01	-	ns
TIOCKOCE						
T <sub>IOSRCKO</sub> /	SR input (OFF)	1.2/0	-	1.3 / 0	-	ns
TIOCKOSR				/ -		
TIOTCK / TIOCKT	3-state setup times, T input	0.8/0	-	0.9/0	-	ns
Т <sub>ІОТСЕСК</sub> /	3-state setup times, TCE input	1.0/0	-	1.0/0	-	ns
		11/0		10/0		
	3-state setup times, SK input (TFF)	1.170	-	1.2/0	-	ns
Set/Reset Delays						
	SR input to pad (asynchronous)	_	37	_	44	ns
	SR input to pad high impedance (asynchronous) <sup>(1)</sup>	-	3.1	-	37	ns
	SR input to valid data on pad (asynchronous)	-	4 1	-	4 Q	ns
	GSR to pad	_	9.1	_	11 7	ns
' IOGSRQ	OUN ID Pau	-	9.9	-	11.7	115

Notes:

1. Three-state turn-off delays should not be adjusted.

2. A zero hold time listing indicates no hold time or a negative hold time.

**Period Tolerance:** the allowed input clock period change in nanoseconds.



**Output Jitter:** the difference between an ideal reference clock edge and the actual design.



Figure 52: Period Tolerance and Clock Jitter

# **Revision History**

Date	Version No.	Description
09/18/00	2.0	Sectioned the Spartan-II Family data sheet into four modules. Updated timing to reflect the latest speed files. Added current supply numbers and XC2S200 -5 timing numbers. Approved -5 timing numbers as preliminary information with exceptions as noted.
11/02/00	2.1	Removed Power Down feature.
01/19/01	2.2	DC and timing numbers updated to Preliminary for the XC2S50 and XC2S100. Industrial power-on current specifications and -6 DLL timing numbers added. Power-on specification clarified.
03/09/01	2.3	Added note on power sequencing. Clarified power-on current requirement.
08/28/01	2.4	Added -6 preliminary timing. Added typical and industrial standby current numbers. Specified min. power-on current by junction temperature instead of by device type (Commercial vs. Industrial). Eliminated minimum $V_{CCINT}$ ramp time requirement. Removed footnote limiting DLL operation to the Commercial temperature range.
07/26/02	2.5	Clarified that I/O leakage current is specified over the Recommended Operating Conditions for $V_{CCINT}$ and $V_{CCO}$ .
08/26/02	2.6	Added references for XAPP450 to Power-On Current Specification.
09/03/03	2.7	Added relaxed minimum power-on current ( $I_{CCPO}$ ) requirements to page 53. On page 64, moved $T_{RPW}$ values from maximum to minimum column.
06/13/08	2.8	Updated I/O measurement thresholds. Updated description and links. Updated all modules for continuous page, figure, and table numbering. Synchronized all modules to v2.8.

Package	Leads	Туре	Maximum I/O	Lead Pitch (mm)	Footprint Area (mm)	Height (mm)	Mass <sup>(1)</sup> (g)
VQ100 / VQG100	100	Very Thin Quad Flat Pack (VQFP)	60	0.5	16 x 16	1.20	0.6
TQ144 / TQG144	144	Thin Quad Flat Pack (TQFP)	92	0.5	22 x 22	1.60	1.4
CS144 / CSG144	144	Chip Scale Ball Grid Array (CSBGA)	92	0.8	12 x 12	1.20	0.3
PQ208 / PQG208	208	Plastic Quad Flat Pack (PQFP)	140	0.5	30.6 x 30.6	3.70	5.3
FG256 / FGG256	256	Fine-pitch Ball Grid Array (FBGA)	176	1.0	17 x 17	2.00	0.9
FG456 / FGG456	456	Fine-pitch Ball Grid Array (FBGA)	284	1.0	23 x 23	2.60	2.2

#### Table 36: Spartan-II Family Package Options

#### Notes:

1. Package mass is  $\pm 10\%$ .

Note: Some early versions of Spartan-II devices, including the XC2S15 and XC2S30 ES devices and the XC2S150 with date code 0045 or earlier, included a power-down pin. For more information, see <u>Answer Record 10500</u>.

# VCCO Banks

Some of the I/O standards require specific V<sub>CCO</sub> voltages. These voltages are externally connected to device pins that serve groups of IOBs, called banks. Eight I/O banks result from separating each edge of the FPGA into two banks (see Figure 3 in Module 2). Each bank has multiple V<sub>CCO</sub> pins which must be connected to the same voltage. In the smaller packages, the V<sub>CCO</sub> pins are connected between banks, effectively reducing the number of independent banks available (see Table 37). These interconnected banks are shown in the Pinout Tables with V<sub>CCO</sub> pads for multiple banks connected to the same pin.

#### Table 37: Independent VCCO Banks Available

Package	VQ100	CS144	FG256
	PQ208	TQ144	FG456
Independent Banks	1	4	8

# Package Overview

Table 36 shows the six low-cost, space-saving productionpackage styles for the Spartan-II family.

Each package style is available in an environmentally friendly lead-free (Pb-free) option. The Pb-free packages include an extra 'G' in the package style name. For example, the standard "CS144" package becomes "CSG144" when ordered as the Pb-free option. Leaded (non-Pb-free) packages may be available for selected devices, with the same pin-out and without the "G" in the ordering code; contact Xilinx sales for more information. The mechanical dimensions of the standard and Pb-free packages are similar, as shown in the mechanical drawings provided in Table 38. For additional package information, see <u>UG112</u>: *Device Package User Guide*.

# **Mechanical Drawings**

Detailed mechanical drawings for each package type are available from the Xilinx web site at the specified location in Table 38.

Material Declaration Data Sheets (MDDS) are also available on the <u>Xilinx web site</u> for each package.

#### Table 38: Xilinx Package Documentation

Package	Drawing	MDDS
VQ100	Package Drawing	PK173_VQ100
VQG100		PK130_VQG100
TQ144	Package Drawing	PK169_TQ144
TQG144		PK126_TQG144
CS144	Package Drawing	PK149_CS144
CSG144		PK103_CSG144
PQ208	Package Drawing	PK166_PQ208
PQG208		PK123_PQG208
FG256	Package Drawing	PK151_FG256
FGG256		PK105_FGG256
FG456	Package Drawing	PK154_FG456
FGG456		PK109_FGG456

# **Pinout Tables**

The following device-specific pinout tables include all packages available for each Spartan<sup>®</sup>-II device. They follow the pad locations around the die, and include Boundary Scan register locations.

## **XC2S15 Device Pinouts**

XC2S15 Pad Name					Bndry
Function	Bank	VQ100	TQ144	CS144	Scan
GND	-	P1	P143	A1	-
TMS	-	P2	P142	B1	-
I/O	7	P3	P141	C2	77
I/O	7	-	P140	C1	80
I/O, V <sub>REF</sub>	7	P4	P139	D4	83
I/O	7	P5	P137	D2	86
I/O	7	P6	P136	D1	89
GND	-	-	P135	E4	-
I/O	7	P7	P134	E3	92
I/O	7	-	P133	E2	95
I/O, V <sub>REF</sub>	7	P8	P132	E1	98
I/O	7	P9	P131	F4	101
I/O	7	-	P130	F3	104
I/O, IRDY <sup>(1)</sup>	7	P10	P129	F2	107
GND	-	P11	P128	F1	-
V <sub>CCO</sub>	7	P12	P127	G2	-
V <sub>CCO</sub>	6	P12	P127	G2	-
I/O, TRDY <sup>(1)</sup>	6	P13	P126	G1	110
V <sub>CCINT</sub>	-	P14	P125	G3	-
I/O	6	-	P124	G4	113
I/O	6	P15	P123	H1	116
I/O, V <sub>REF</sub>	6	P16	P122	H2	119
I/O	6	-	P121	H3	122
I/O	6	P17	P120	H4	125
GND	-	-	P119	J1	-
I/O	6	P18	P118	J2	128
I/O	6	P19	P117	J3	131
I/O, V <sub>REF</sub>	6	P20	P115	K1	134
I/O	6	-	P114	K2	137
I/O	6	P21	P113	K3	140
I/O	6	P22	P112	L1	143
M1	-	P23	P111	L2	146
GND	-	P24	P110	L3	-
M0	-	P25	P109	M1	147
V <sub>CCO</sub>	6	P26	P108	M2	-
V <sub>CCO</sub>	5	P26	P107	N1	-

## XC2S15 Device Pinouts (Continued)

XC2S15 Pad Name					Bndry
Function	Bank	VQ100	TQ144	CS144	Scan
M2	-	P27	P106	N2	148
I/O	5	-	P103	K4	155
I/O, V <sub>REF</sub>	5	P30	P102	L4	158
I/O	5	P31	P100	N4	161
I/O	5	P32	P99	K5	164
GND	-	-	P98	L5	-
V <sub>CCINT</sub>	-	P33	P97	M5	-
I/O	5	-	P96	N5	167
I/O	5	-	P95	K6	170
I/O, V <sub>REF</sub>	5	P34	P94	L6	173
I/O	5	-	P93	M6	176
V <sub>CCINT</sub>	-	P35	P92	N6	-
I, GCK1	5	P36	P91	M7	185
V <sub>CCO</sub>	5	P37	P90	N7	-
V <sub>CCO</sub>	4	P37	P90	N7	-
GND	-	P38	P89	L7	-
I, GCK0	4	P39	P88	K7	186
I/O	4	P40	P87	N8	190
I/O	4	-	P86	M8	193
I/O, V <sub>REF</sub>	4	P41	P85	L8	196
I/O	4	-	P84	K8	199
I/O	4	-	P83	N9	202
V <sub>CCINT</sub>	-	P42	P82	M9	-
GND	-	-	P81	L9	-
I/O	4	P43	P80	K9	205
I/O	4	P44	P79	N10	208
I/O, V <sub>REF</sub>	4	P45	P77	L10	211
I/O	4	-	P76	N11	214
I/O	4	P46	P75	M11	217
I/O	4	P47	P74	L11	220
GND	-	P48	P73	N12	-
DONE	3	P49	P72	M12	223
V <sub>CCO</sub>	4	P50	P71	N13	-
V <sub>CCO</sub>	3	P50	P70	M13	-
PROGRAM	-	P51	P69	L12	226
I/O (INIT)	3	P52	P68	L13	227
I/O (D7)	3	P53	P67	K10	230
I/O	3	-	P66	K11	233
I/O, V <sub>REF</sub>	3	P54	P65	K12	236
I/O	3	P55	P63	J10	239
I/O (D6)	3	P56	P62	J11	242

## Additional XC2S100 Package Pins

#### TQ144

Not Connected Pins							
P104	P105	-	-	-	-		
11/02/00							

# PQ208

Not Connected Pins							
P55	P56	-	-	-	-		
11/02/00							

#### FG256

V <sub>CCINT</sub> Pins								
C3	C14	D4	D13	E5	E12			
M5	M12	N4	N13	P3	P14			
		V <sub>CCO</sub> Ba	nk 0 Pins					
E8	F8	-	-	-	-			
		V <sub>CCO</sub> Ba	nk 1 Pins					
E9	F9	-	-	-	-			
		V <sub>CCO</sub> Ba	nk 2 Pins					
H11	H12	-	-	-	-			
		V <sub>CCO</sub> Ba	nk 3 Pins					
J11	J12	-	-	-	-			
	V <sub>CCO</sub> Bank 4 Pins							
L9	M9	-	-	-	-			
V <sub>CCO</sub> Bank 5 Pins								
L8	M8	-	-	-	-			
		V <sub>CCO</sub> Ba	nk 6 Pins					
J5	J6	-	-	-	-			
		V <sub>CCO</sub> Ba	nk 7 Pins					
H5	H6	-	-	-	-			
		GND	Pins					
A1	A16	B2	B15	F6	F7			
F10	F11	G6	G7	G8	G9			
G10	G11	H7	H8	H9	H10			
J7	J8	J9	J10	K6	K7			
K8	K9	K10	K11	L6	L7			
L10	L11	R2	R15	T1	T16			
		Not Conne	ected Pins					
P4	R4	-	-	-	-			

## 11/02/00

#### FG456

V <sub>CCINT</sub> Pins							
E5	E18	F6	F17	G7	G8		
G9	G14	G15	G16	H7	H16		
J7	J16	P7	P16	R7	R16		
T7	T8	Т9	T14	T15	T16		
U6	U17	V5	V18	-	-		
	V <sub>CCO</sub> Bank 0 Pins						

## Additional XC2S100 Package Pins (Continued)

V <sub>CCO</sub> Bank 1 Pins           F13         F14         F15         F16         G12         G13           V <sub>CCO</sub> Bank 2 Pins           G17         H17         J17         K16         K17         L16           V <sub>CCO</sub> Bank 3 Pins           M16         N16         N17         P17         R17         T17           V <sub>CCO</sub> Bank 4 Pins           T12         T13         U13         U14         U15         U16           V <sub>CCO</sub> Bank 5 Pins           T10         T11         U10         U7         U8         U9           V <sub>CCO</sub> Bank 6 Pins           M7         N6         N7         P6         R6         T6           G6         H6         J6         K6         K7         L7           G10         J11         J12         J13         J14           K9         K10         K11         K12         K13         K14           L9         L10         L11         L12         L13         L14           M9         M10         M11         M12         M13         M14           N9         N10 <th< th=""></th<>
F13         F14         F15         F16         G12         G13           V <sub>CC0</sub> Bank 2 Pins           G17         H17         J17         K16         K17         L16           V <sub>CC0</sub> Bank 3 Pins           M16         N16         N17         P17         R17         T17           V <sub>CC0</sub> Bank 4 Pins           T12         T13         U13         U14         U15         U16           V <sub>CC0</sub> Bank 4 Pins           T10         T11         U10         U7         U8         U9           V <sub>CC0</sub> Bank 5 Pins           T10         T11         U10         U7         U8         U9           V <sub>CC0</sub> Bank 6 Pins           M7         N6         N7         P6         R6         T6           G10         T11         U10         U7         U8         U9           V <sub>CC0</sub> Bank 7 Pins           G6         H6         J6         K6         K7         L7           GND Pins           A1         A22         B2         B21         C3         C20           J9         J10         J11         <
V <sub>CCO</sub> Bank 2 Pins           G17         H17         J17         K16         K17         L16           V <sub>CCO</sub> Bank 3 Pins           M16         N16         N17         P17         R17         T17           V <sub>CCO</sub> Bank 4 Pins           T12         T13         U13         U14         U15         U16           V <sub>CCO</sub> Bank 5 Pins           T10         T11         U10         U7         U8         U9           V <sub>CCO</sub> Bank 6 Pins           M7         N6         N7         P6         R6         T6           G6         H6         J6         K6         K7         L7           G10         N11         J12         J13         J14           M7         N6         N7         P6         R6         T6           V <sub>CCO</sub> Bank 7 Pins           G6         H6         J6         K6         K7         L7           G10         J11         J12         J13         J14           K9         K10         K11         K12         K13         K14           L9         L10         L11         <
G17         H17         J17         K16         K17         L16           VCC0 Bank 3 Pins         VCC0 Bank 3 Pins         VC00 Bank 4 Pins         T17           M16         N16         N17         P17         R17         T17           VCC0 Bank 4 Pins         U13         U14         U15         U16           VCC0 Bank 5 Pins         U16         U9         VC00 Bank 5 Pins           T10         T11         U10         U7         U8         U9           VCC0 Bank 5 Pins         V00         U7         U8         U9           VCC0 Bank 5 Pins         U9         U9         U9         U9           VCC0 Bank 7 Pins         G6         T6         T6           VCC0 Bank 7 Pins         G6         H6         J6         K6         K7         L7           G6         H6         J6         K6         K7         L7           G1         A22         B2         B21         C3         C20           J9         J10         J11         J12         J13         J14           K9         K10         K11         K12         K13         K14           L9         L10         L11 <th< td=""></th<>
V <sub>CCO</sub> Bank 3 Pins           M16         N16         N17         P17         R17         T17           V <sub>CCO</sub> Bank 4 Pins           T12         T13         U13         U14         U15         U16           V <sub>CCO</sub> Bank 5 Pins           T10         T11         U10         U7         U8         U9           V <sub>CCO</sub> Bank 6 Pins           M7         N6         N7         P6         R6         T6           V <sub>CCO</sub> Bank 7 Pins           G6         H6         J6         K6         K7         L7           GND Pins           A1         A22         B2         B21         C3         C20           J9         J10         J11         J12         J13         J14           K9         K10         K11         K12         K13         K14           L9         L10         L11         L12         L13         L14           M9         M10         M11         M12         M13         M14           P9         P10         P11         P12         P13         P14           Y3         Y20         AA2         <
M16         N16         N17         P17         R17         T17           VCC0 Bank 4 Pins         VCC0 Bank 4 Pins         U15         U16           VCC0 Bank 5 Pins         VI16         VI6           VCC0 Bank 5 Pins         U18         U9           T10         T11         U10         U7         U8         U9           VCC0 Bank 6 Pins         V         V         V         V         V           M7         N6         N7         P6         R6         T6           VCC0 Bank 7 Pins         C3         C20         C3         C20           G6         H6         J6         K6         K7         L7           G7         N6         N11         J12         J13         J14           K10         J11         J12         J13         J14           K9         K10         K11         K12         K13         K14           L9         L10         L11         L12         L13         L14           M9         M10         M11         M12         M13         M14           M9         N10         N11         N12         M13         M14           Y3
V <sub>CCO</sub> Bank 4 Pins           T12         T13         U13         U14         U15         U16           V <sub>CCO</sub> Bank 5 Pins           T10         T11         U10         U7         U8         U9           V <sub>CCO</sub> Bank 6 Pins           M7         N6         N7         P6         R6         T6           V <sub>CCO</sub> Bank 7 Pins           G6         H6         J6         K6         K7         L7           GND Pins           A1         A22         B2         B21         C3         C20           J9         J10         J11         J12         J13         J14           K9         K10         K11         K12         K13         K14           L9         L10         L11         L12         L13         L14           M9         M10         M11         M12         M13         M14           P9         P10         P11         P12         P13         P14           Y3         Y20         AA2         AA21         AB1         AB22           Not Connected Pins            P2         P3
T12         T13         U13         U14         U15         U16           V <sub>CC0</sub> Bank 5 Pins           T10         T11         U10         U7         U8         U9           V <sub>CC0</sub> Bank 6 Pins           M7         N6         N7         P6         R6         T6           V <sub>CC0</sub> Bank 7 Pins           G6         H6         J6         K6         K7         L7           GND Pins           A1         A22         B2         B21         C3         C20           J9         J10         J11         J12         J13         J14           K9         K10         K11         K12         K13         K14           L9         L10         L11         L12         L13         L14           M9         M10         M11         M12         M13         M14           N9         N10         N11         N12         N13         N14           P9         P10         P11         P12         P13         P14           Y3         Y20         AA2         AA21         AB1         AB22           Not Connected Pins
V <sub>CCO</sub> Bank 5 Pins           T10         T11         U10         U7         U8         U9           V <sub>CCO</sub> Bank 6 Pins         V <sub>CCO</sub> Bank 6 Pins         T6         T6           M7         N6         N7         P6         R6         T6           V <sub>CCO</sub> Bank 7 Pins           G6         H6         J6         K6         K7         L7           GND Pins           A1         A22         B2         B21         C3         C20           J9         J10         J11         J12         J13         J14           K9         K10         K11         K12         K13         K14           L9         L10         L11         L12         L13         L14           M9         M10         M11         M12         M13         M14           N9         N10         N11         N12         N13         N14           P9         P10         P11         P12         P13         P14           Y3         Y20         AA2         AA21         AB1         AB22           Not Connected Pins           A2         A4         A5
T10         T11         U10         U7         U8         U9           V <sub>CC0</sub> Bank 6 Pins           M7         N6         N7         P6         R6         T6           V <sub>CC0</sub> Bank 7 Pins           G6         H6         J6         K6         K7         L7           GND Pins           A1         A22         B2         B21         C3         C20           J9         J10         J11         J12         J13         J14           K9         K10         K11         K12         K13         K14           L9         L10         L11         L12         L13         L14           M9         M10         M11         M12         M13         M14           P9         P10         P11         P12         P13         P14           Y3         Y20         AA2         AA21         AB1         AB22           Not Connected Pins           A2         A4         A5         A6         A12         A13
V <sub>CCO</sub> Bank 6 Pins           M7         N6         N7         P6         R6         T6           V <sub>CCO</sub> Bank 7 Pins           G6         H6         J6         K6         K7         L7           GND Pins           A1         A22         B2         B21         C3         C20           J9         J10         J11         J12         J13         J14           K9         K10         K11         K12         K13         K14           L9         L10         L11         L12         L13         L14           M9         M10         M11         M12         M13         M14           P9         P10         P11         P12         P13         P14           Y3         Y20         AA2         AA21         AB1         AB22           A2         A4         A5         A6         A12         A13
M7         N6         N7         P6         R6         T6           V <sub>CC0</sub> Bank 7 Pins           G6         H6         J6         K6         K7         L7           GND Pins           A1         A22         B2         B21         C3         C20           J9         J10         J11         J12         J13         J14           K9         K10         K11         K12         K13         K14           L9         L10         L11         L12         L13         L14           M9         M10         M11         M12         M13         M14           P9         P10         P11         P12         P13         P14           Y3         Y20         AA2         AA21         AB1         AB22           Not Connected Pins           A2         A4         A5         A6         A12         A13
V <sub>CCO</sub> Bank 7 Pins           G6         H6         J6         K6         K7         L7           GND Pins           A1         A22         B2         B21         C3         C20           J9         J10         J11         J12         J13         J14           K9         K10         K11         K12         K13         K14           L9         L10         L11         L12         L13         L14           M9         M10         M11         M12         M13         M14           P9         P10         P11         P12         P13         P14           Y3         Y20         AA2         AA21         AB1         AB22           Not Connected Pins           A2         A4         A5         A6         A12         A13
G6         H6         J6         K6         K7         L7           GND Pins           A1         A22         B2         B21         C3         C20           J9         J10         J11         J12         J13         J14           K9         K10         K11         K12         K13         K14           L9         L10         L11         L12         L13         L14           M9         M10         M11         M12         M13         M14           P9         P10         P11         P12         P13         P14           Y3         Y20         AA2         AA21         AB1         AB22           Not Connected Pins           A2         A4         A5         A6         A12         A13
GND Pins           A1         A22         B2         B21         C3         C20           J9         J10         J11         J12         J13         J14           K9         K10         K11         K12         K13         K14           L9         L10         L11         L12         L13         L14           M9         M10         M11         M12         M13         M14           N9         N10         N11         N12         N13         N14           P9         P10         P11         P12         P13         P14           Y3         Y20         AA2         AA21         AB1         AB22           Not Connected Pins           A2         A4         A5         A6         A12         A13
A1         A22         B2         B21         C3         C20           J9         J10         J11         J12         J13         J14           K9         K10         K11         K12         K13         K14           L9         L10         L11         L12         L13         L14           M9         M10         M11         M12         M13         M14           P9         P10         P11         P12         P13         P14           Y3         Y20         AA2         AA21         AB1         AB22           Not Connected Pins           A2         A4         A5         A6         A12         A13
J9         J10         J11         J12         J13         J14           K9         K10         K11         K12         K13         K14           L9         L10         L11         L12         L13         L14           M9         M10         M11         M12         M13         M14           N9         N10         N11         N12         N13         N14           P9         P10         P11         P12         P13         P14           Y3         Y20         AA2         AA21         AB1         AB22           Not Connected Pins           A2         A4         A5         A6         A12         A13
K9         K10         K11         K12         K13         K14           L9         L10         L11         L12         L13         L14           M9         M10         M11         M12         M13         M14           N9         N10         N11         N12         N13         N14           P9         P10         P11         P12         P13         P14           Y3         Y20         AA2         AA21         AB1         AB22           Not Connected Pins           A2         A4         A5         A6         A12         A13
L9         L10         L11         L12         L13         L14           M9         M10         M11         M12         M13         M14           N9         N10         N11         N12         N13         N14           P9         P10         P11         P12         P13         P14           Y3         Y20         AA2         AA21         AB1         AB22           Not Connected Pins           A2         A4         A5         A6         A12         A13
M9         M10         M11         M12         M13         M14           N9         N10         N11         N12         N13         N14           P9         P10         P11         P12         P13         P14           Y3         Y20         AA2         AA21         AB1         AB22           Not Connected Pins           A2         A4         A5         A6         A12         A13
N9         N10         N11         N12         N13         N14           P9         P10         P11         P12         P13         P14           Y3         Y20         AA2         AA21         AB1         AB22           Not Connected Pins           A2         A4         A5         A6         A12         A13
P9         P10         P11         P12         P13         P14           Y3         Y20         AA2         AA21         AB1         AB22           Not Connected Pins           A2         A4         A5         A6         A12         A13           A14         A15         A47         D2         D2         D2
Y3         Y20         AA2         AA21         AB1         AB22           Not Connected Pins         A2         A4         A5         A6         A12         A13           A14         A15         A47         B2         <
A2         A4         A5         A6         A12         A13           A14         A15         A47         D2         D2         D2
A2 A4 A5 A6 A12 A13
A14 A15 A17 B3 B6 B8
B11 B14 B16 B19 C1 C2
C8 C9 C12 C18 C22 D1
D4 D5 D10 D18 D19 D21
E4 E11 E13 E15 E16 E17
E19 E22 F4 F11 F22 G2
G3 G4 G19 G22 H1 H21
J1 J3 J4 J19 J20 K2
K18 K19 L2 L5 L18 L19
M2 M6 M17 M18 M21 N1
N5 N19 P1 P5 P19 P22
R1 R3 R20 R22 T5 T19
U3 U11 U18 V1 V2 V10
V12 V17 V3 V4 V6 V8
V20 V21 V22 W4 W5 W9
W13 W14 W15 W16 W19 Y5
Y14         Y18         Y22         AA1         AA3         AA6
AA9 AA10 AA11 AA16 AA17 AA18
AA22 AB3 AB4 AB7 AB8 AB12
AB14 AB21

# XC2S150 Device Pinouts (Continued)

XC2S150 Pad Name					Bndry
Function	Bank	PQ208	FG256	FG456	Scan
I/O, IRDY <sup>(1)</sup>	2	P132	H16	L20	767
I/O	2	P133	H14	L17	770
I/O	2	-	-	L18	773
I/O	2	P134	H15	L21	776
I/O	2	-	J13	L22	779
I/O (D3)	2	P135	G16	K20	782
I/O, V <sub>REF</sub>	2	P136	H13	K21	785
V <sub>CCO</sub>	2	-	V <sub>CCO</sub> Bank 2*	V <sub>CCO</sub> Bank 2*	-
GND	-	P137	GND*	GND*	-
I/O	2	P138	G14	K22	788
I/O	2	P139	G15	J21	791
I/O	2	-	-	J20	797
I/O	2	P140	G12	J18	800
I/O	2	-	F16	J22	803
I/O	2	-	-	J19	806
I/O	2	P141	G13	H19	812
I/O (D2)	2	P142	F15	H20	815
V <sub>CCINT</sub>	-	P143	V <sub>CCINT</sub> *	V <sub>CCINT</sub> *	-
V <sub>CCO</sub>	2	P144	V <sub>CCO</sub> Bank 2*	V <sub>CCO</sub> Bank 2*	-
GND	-	P145	GND*	GND*	-
I/O (D1)	2	P146	E16	H22	818
I/O, V <sub>REF</sub>	2	P147	F14	H18	821
I/O	2	-	-	G21	824
I/O	2	P148	D16	G18	827
I/O	2	-	F12	G20	830
I/O	2	-	-	G19	833
I/O	2	-	-	F22	836
I/O	2	P149	E15	F19	839
I/O, V <sub>REF</sub>	2	P150	F13	F21	842
V <sub>CCO</sub>	2	-	V <sub>CCO</sub> Bank 2*	V <sub>CCO</sub> Bank 2*	-
GND	-	-	GND*	GND*	-
I/O	2	P151	E14	F20	845
I/O	2	-	C16	F18	848
I/O	2	-	-	E22	851
I/O	2	-	-	E21	854
I/O	2	P152	E13	D22	857
GND	-	-	GND*	GND*	-
I/O	2	-	B16	E20	860
I/O	2	-	-	D21	863

# XC2S150 Device Pinouts (Continued)

XC2S150 Pad Name					Bndry
Function	Bank	PQ208	FG256	FG456	Scan
I/O	2	-	-	C22	866
I/O (DIN, D0)	2	P153	D14	D20	869
I/O (DOUT, BUSY)	2	P154	C15	C21	872
CCLK	2	P155	D15	B22	875
V <sub>CCO</sub>	2	P156	V <sub>CCO</sub> Bank 2*	V <sub>CCO</sub> Bank 2*	-
V <sub>CCO</sub>	1	P156	V <sub>CCO</sub> Bank 1*	V <sub>CCO</sub> Bank 1*	-
TDO	2	P157	B14	A21	-
GND	-	P158	GND*	GND*	-
TDI	-	P159	A15	B20	-
I/O ( <u>CS</u> )	1	P160	B13	C19	0
I/O (WRITE)	1	P161	C13	A20	3
I/O	1	-	-	B19	6
I/O	1	-	-	C18	9
I/O	1	-	C12	D17	12
GND	-	-	GND*	GND*	-
I/O	1	P162	A14	A19	15
I/O	1	-	-	B18	18
I/O	1	-	-	E16	21
I/O	1	-	D12	C17	24
I/O	1	P163	B12	D16	27
GND	-	-	GND*	GND*	-
V <sub>CCO</sub>	1	-	V <sub>CCO</sub> Bank 1*	V <sub>CCO</sub> Bank 1*	-
I/O, V <sub>REF</sub>	1	P164	C11	A18	30
I/O	1	P165	A13	B17	33
I/O	1	-	-	E15	36
I/O	1	-	-	A17	39
I/O	1	-	D11	D15	42
I/O	1	P166	A12	C16	45
I/O	1	-	-	D14	48
I/O, V <sub>REF</sub>	1	P167	E11	E14	51
I/O	1	P168	B11	A16	54
GND	-	P169	GND*	GND*	-
V <sub>CCO</sub>	1	P170	V <sub>CCO</sub> Bank 1*	V <sub>CCO</sub> Bank 1*	-
V <sub>CCINT</sub>	-	P171	V <sub>CCINT</sub> *	$V_{CCINT}^{*}$	-
I/O	1	P172	A11	C15	57
I/O	1	P173	C10	B15	60
I/O	1	-	-	A15	66
I/O	1	-	-	F12	69

# XC2S200 Device Pinouts (Continued)

XC2S200 Pad Name					Bndry
Function	Bank	PQ208	FG256	FG456	Scan
I/O	6	-	-	T2	449
I/O	6	P43	L4	U1	452
GND	-	-	GND*	GND*	-
I/O	6	-	M2	R5	455
I/O	6	-	-	V1	458
I/O	6	-	-	T5	461
I/O	6	P44	L3	U2	464
I/O, V <sub>REF</sub>	6	P45	N1	Т3	467
V <sub>CCO</sub>	6	-	V <sub>CCO</sub> Bank 6*	V <sub>CCO</sub> Bank 6*	-
GND	-	-	GND*	GND*	-
I/O	6	P46	P1	T4	470
I/O	6	-	L5	W1	473
GND	-	-	GND*	GND*	-
I/O	6	-	-	V2	476
I/O	6	-	-	U4	482
I/O, V <sub>REF</sub>	6	P47	N2	Y1	485
GND	-	-	GND*	GND*	-
I/O	6	-	M4	W2	488
I/O	6	-	-	V3	491
I/O	6	-	-	V4	494
I/O	6	P48	R1	Y2	500
I/O	6	P49	M3	W3	503
M1	-	P50	P2	U5	506
GND	-	P51	GND*	GND*	-
MO	-	P52	N3	AB2	507
V <sub>CCO</sub>	6	P53	V <sub>CCO</sub> Bank 6*	V <sub>CCO</sub> Bank 6*	-
V <sub>CCO</sub>	5	P53	V <sub>CCO</sub> Bank 5*	V <sub>CCO</sub> Bank 5*	-
M2	-	P54	R3	Y4	508
I/O	5	-	-	W5	518
I/O	5	-	-	AB3	521
I/O	5	-	N5	V7	524
GND	-	-	GND*	GND*	-
I/O, V <sub>REF</sub>	5	P57	T2	Y6	527
I/O	5	-	-	AA4	530
I/O	5	-	-	AB4	536
I/O	5	-	P5	W6	539
I/O	5	P58	Т3	Y7	542
GND	-	-	GND*	GND*	-

# XC2S200 Device Pinouts (Continued)

XC2S200 Pa	d Name				Bndry
Function	Bank	PQ208	FG256	FG456	Scan
V <sub>CCO</sub>	5	-	V <sub>CCO</sub> Bank 5*	V <sub>CCO</sub> Bank 5*	-
I/O, V <sub>REF</sub>	5	P59	T4	AA5	545
I/O	5	P60	M6	AB5	548
I/O	5	-	-	V8	551
I/O	5	-	-	AA6	554
I/O	5	-	T5	AB6	557
GND	-	-	GND*	GND*	-
I/O	5	P61	N6	AA7	560
I/O	5	-	-	W7	563
I/O, V <sub>REF</sub>	5	P62	R5	W8	569
I/O	5	P63	P6	Y8	572
GND	-	P64	GND*	GND*	-
V <sub>CCO</sub>	5	P65	V <sub>CCO</sub> Bank 5*	V <sub>CCO</sub> Bank 5*	-
V <sub>CCINT</sub>	-	P66	V <sub>CCINT</sub> *	V <sub>CCINT</sub> *	-
I/O	5	P67	R6	AA8	575
I/O	5	P68	M7	V9	578
I/O	5	-	-	AB8	581
I/O	5	-	-	W9	584
I/O	5	-	-	AB9	587
GND	-	-	GND*	GND*	-
I/O	5	P69	N7	Y9	590
I/O	5	-	-	V10	593
I/O	5	-	-	AA9	596
I/O	5	P70	Т6	W10	599
I/O	5	P71	P7	AB10	602
GND	-	P72	GND*	GND*	-
V <sub>CCO</sub>	5	-	V <sub>CCO</sub> Bank 5*	V <sub>CCO</sub> Bank 5*	-
I/O, V <sub>REF</sub>	5	P73	P8	Y10	605
I/O	5	P74	R7	V11	608
I/O	5	-	-	AA10	614
I/O	5	-	T7	W11	617
I/O	5	P75	T8	AB11	620
I/O	5	-	-	U11	623
V <sub>CCINT</sub>	-	P76	V <sub>CCINT</sub> *	V <sub>CCINT</sub> *	-
I, GCK1	5	P77	R8	Y11	635
V <sub>CCO</sub>	5	P78	V <sub>CCO</sub> Bank 5*	V <sub>CCO</sub> Bank 5*	-
V <sub>CCO</sub>	4	P78	V <sub>CCO</sub> Bank 4*	V <sub>CCO</sub> Bank 4*	-
GND	-	P79	GND*	GND*	-